

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MING-YEH CHUANG	01/14/2019
ELIZABETH COSTNER STEWART	01/16/2019
RECEIVING PARTY DATA	
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State/Country:	TEXAS
Postal Code:	75243
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16270729
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ATTORNEY DOCKET NUMBER:	TI-90050
NAME OF SUBMITTER:	ARLENE J. SIMON
SIGNATURE:	/Arlene J. Simon/
DATE SIGNED:	02/08/2019
Total Attachments: 2	
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source=TI-90050-Assignment#page2.tif	

Serial No.

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.


WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon.

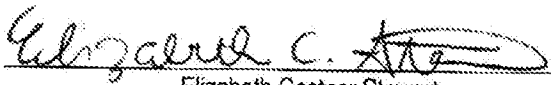
NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign to the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in to the said application and all patents which may be granted therefore, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Commissioner of Patents and Trademarks to issue all patents for said invention, or patent resulting therefrom, insofar as my interest is concerned, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my foreign rights to the invention disclosed in said application, in all countries of the world, including the right to file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such patent rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE OF INVENTION	TRANSISTOR WITH FIELD PLATE OVER TAPERED TRENCH ISOLATION
SIGNATURE OF INVENTOR AND NAME	 Ming-Yeh Chuang
DATE	1/14/2019
RESIDENCE (CITY AND STATE)	McKinney, TX

TITLE OF INVENTION	TRANSISTOR WITH FIELD PLATE OVER TAPERED TRENCH ISOLATION
SIGNATURE OF INVENTOR AND NAME	 Elizabeth Costner Stewart
DATE	1-16-19
RESIDENCE (CITY AND STATE)	Dallas, TX

After recording, return Assignment to:

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